

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Wen-Kuei Tsai</td><td>08/10/2007</td></tr><tr><td>Chun-Chien Wang</td><td>08/10/2007</td></tr></tbody></table>	Name	Execution Date	Wen-Kuei Tsai	08/10/2007	Chun-Chien Wang	08/10/2007	
Name	Execution Date						
Wen-Kuei Tsai	08/10/2007						
Chun-Chien Wang	08/10/2007						
RECEIVING PARTY DATA							
Name:	TOPCO TECHNOLOGIES CORP.						
Street Address:	14F., No. 102, Sec. 4, Civic Blvd., Da-an District,						
City:	Taipei City						
State/Country:	TAIWAN						
Postal Code:	106						
PROPERTY NUMBERS Total: 1							
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11839510</td></tr></tbody></table>	Property Type	Number	Application Number:	11839510			
Property Type	Number						
Application Number:	11839510						
CORRESPONDENCE DATA							
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ATTORNEY DOCKET NUMBER:	24277-US-PA						
NAME OF SUBMITTER:	Belinda Lee						
Total Attachments: 2 source=24277assignment#page1.tif source=24277assignment#page2.tif							

CH 11839510 \$40.00

ASSIGNMENT

WHEREAS,

1. Tsai, Wen-Kuei

2. Wang, Chun-Chien

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **LIGHT EMITTING DIODE LAMP AND ILLUMINATION SYSTEM**

[] Filed:

Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, TOPCO TECHNOLOGIES CORP.

of 14F., No. 102, Sec. 4, Civic Blvd., Da-an District, Taipei City 106, Taiwan,
R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Wen-Kuei Tsai

Date: August 10, 2007

Sole or First Joint Inventor: Tsai, Wen-Kuei

Signature: Wang, Chun-Chien

Date: August 10, 2007

Second Joint Inventor (if any): Wang, Chun-Chien